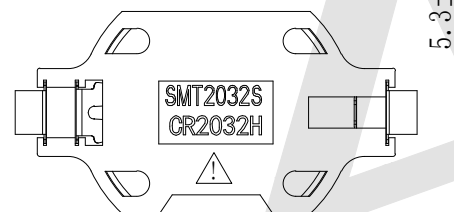
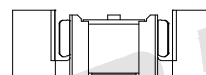
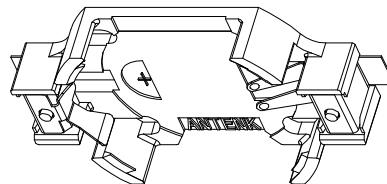
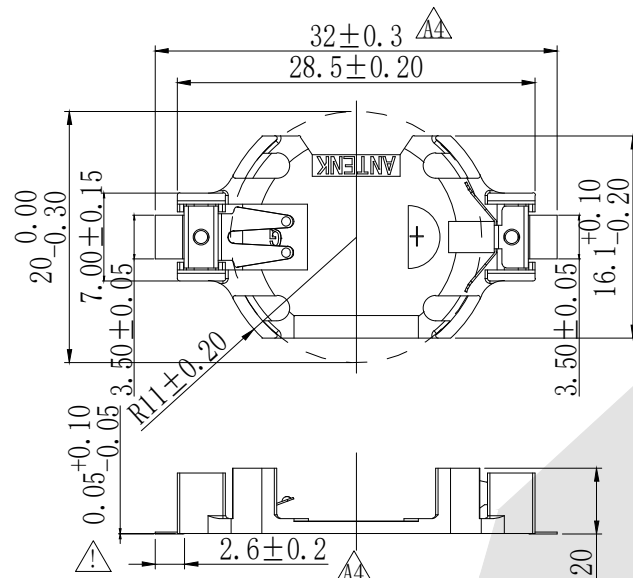


HSF



RoHS



PCB LAYOUT (TOP VIEW)

NOTES:

1. Housing:

LCP+30%G. F, Colr:Nature, UL94V-0

2. Contact: Spring Stainless

Steel, T=0.15mm

Solder area: 200u" Tin Plated

50u" Nickel Min

Under-Overall;

3. Working Temp: -30° C to +70° C

Order code:

BT - M - SN - X - SMT2032S

① ② ③ ④ ⑤

① BT:Coin Cell Holders

② Apperance for the product
M:SMT TYPE

③ Contact Plating

SN: Tin

G0: Gold flash

G1: 3U" Gold

G2: 5U" Gold

G3: 10U" Gold

G4: 15U" Gold

G5: 30U" Gold

④ Packing method

A: Tray packing

R: Tape & reel packing

⑤ Product number

SMT2032S

Unless Otherwise specified tolerance
X. ±0.38 X. XX: ±0.20
X. X: ±0.25 X. XXX: ±0.10

SCALE: As Shown UNIT: mm
DRAW Jacky DATE 11/17/2020
CHECK BobYang DATE 11/17/2020



TITLE: Coin Cell Holders SMT For 2032

DRAWING NO: BT-M-SN-A-SMT2032S

PRODUCT NO: BT-M-SN-A-SMT2032S

Change 32 to 32.2, 2.3 to 2.6

12/15/2023

Update Remarks

08/05/2021

Update Flatness

07/07/2021

Change DIP TO SMT

01/28/2021

REV

DESCRIPTION

DATE